

5mm Blinking (Red + Pure Green + Blue) LED Lamps B500RGB4F-BK

*5mm with FLASH IC and Red and Pure Green and Blue Dice $\,\circ\,$

*Encapsulated with Water Clear Package 。

*Long Leads $\,^\circ$

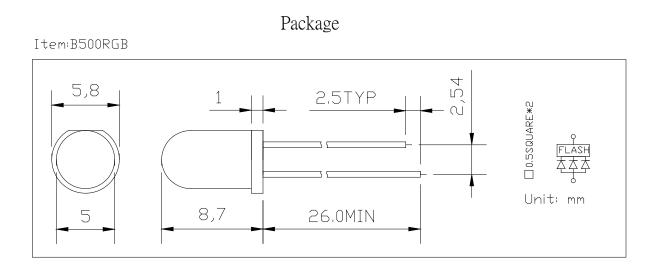
Absolute Maximum Ratings :

Parameter	Maximum Rating	Unit			
Peak Forward Current	120	mA			
Continuous Forward Current	30	mA			
Operating Temperature Range	-20° C to $+75^{\circ}$ C				
Storage Temperature Range	-25° C to $+85^{\circ}$ C				
Lead Soldering Temperature	260° C for 3 seconds				
	1.6mm $(0.063$ inch) from body				

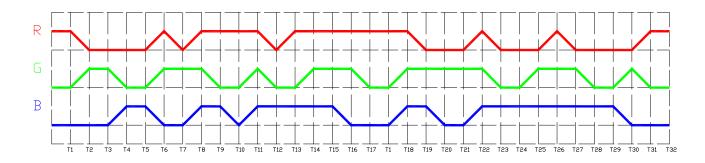
Electro-Optical Characteristics ($Ta = 25^{\circ}C$)

Parameter Radiant	Test Condition	Symbol		Min.	Тур.	Max.	Unit
			R		2.0	2.4	
Forward Voltage	If $= 20 \text{mA}$	Vf	G		3.2	3.6	V
			В		3.2	3.6	
Reverse Current	Vr = 5V	Ir				10	uA
Luminous Flux		Iv	R		600		mcd
	If $= 20mA$		G		1000		
			В		400		
Spectral Bandwidth		Δλ	R		25		nm
	If $= 20 \text{mA}$		G		30		
			В		30		
Wavelength	If $= 20mA$	λp	R	620	625	630	nm
			G	515	520	525	
			В	460	465	470	
			R		625		
		λd	G		525		nm
			В		470		
Half View Angle	If $= 20 \text{mA}$	2 θ 1/2			25		deg





Flash Picture





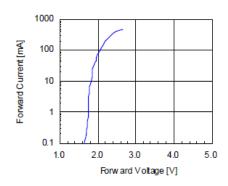


Fig 3. Forward Voltage vs. Temperature

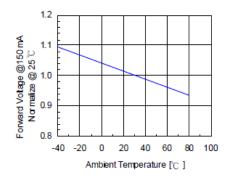
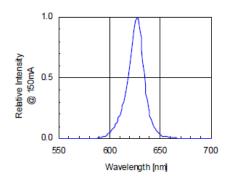


Fig 5. Relative Intensity vs. Wavelength



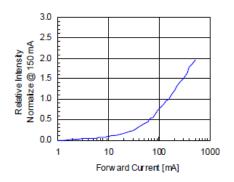


Fig 4. Relative Intensity vs. Temperature

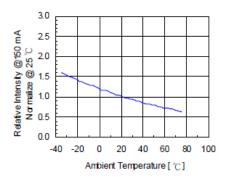




Fig 1. Forward Current vs. Forward Voltage

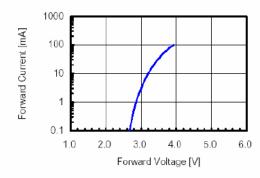


Fig 3. Forward Voltage vs. Temperature

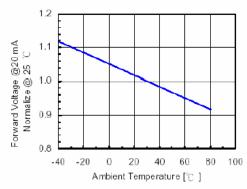


Fig 5.Relative Intensity vs. Wavelength

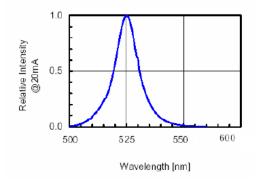


Fig 2. Relative Intensity vs. Forward Current

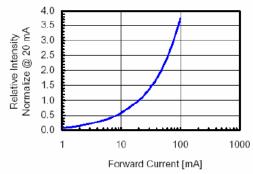


Fig 4. Relative Intensity vs. Temperature

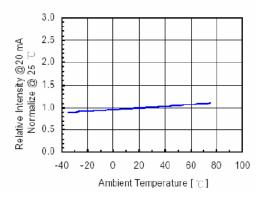




Fig 1. Forward Current vs. Forward Voltage

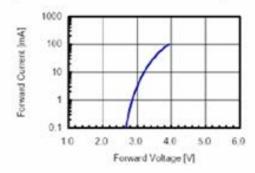


Fig 3. Forward Voltage vs. Temperature

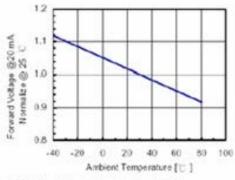


Fig 5.Relative Intensity vs. Wavelength

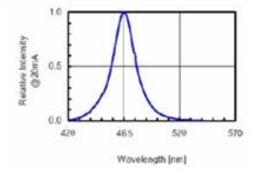
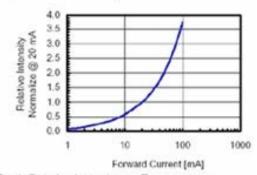
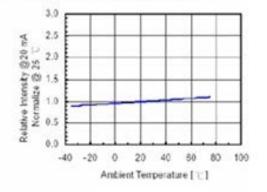


Fig 2. Relative Intensity vs. Forward Current









•Soldering:

1. Manual of soldering

The temperature of the iron tip should not be higher than 260

Soldering within 3 seconds per solder-land is to be observed

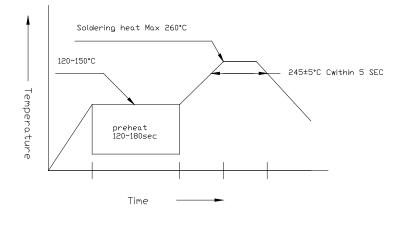
2. DIP soldering (Wave Soldering):

Preheating:120

 $^{\circ}C^{\sim}150^{\circ}C$ within 5 sec.260 $^{\circ}C(Max)$

°Cand

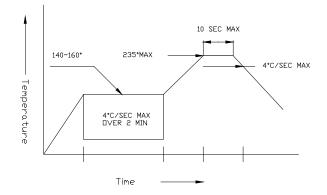
Gradual Cooling (Avoid quenching)



3. Reflow Soldering Preheating:140 **Operation heating:235**

°C~160°C±5°C.within 2 minutes. °C(Max)within 10 seconds(Max)

Gradual Cooling (Avoid quenching)



•Handling:

Care must be taken not to cause to the epoxy resin portion of Yetda LEDS while it is exposed to high temperature.

Care must be taken not rub the epoxy resin portion of Yetda LEDS with hard or sharp article such as the sand blast and the metal hook